One-of-Ten Decoder

The LSTTL/MSI SN74LS42 is a Multipurpose Decoder designed to accept four BCD inputs and provide ten mutually exclusive outputs. The LS42 is fabricated with the Schottky barrier diode process for high speed and is completely compatible with all ON Semiconductor TTL families.

- Multifunction Capability
- Mutually Exclusive Outputs
- Demultiplexing Capability
- Input Clamp Diodes Limit High Speed Termination Effects



ON Semiconductor Formerly a Division of Motorola http://onsemi.com

LOW POWER SCHOTTKY

GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Тур	Мах	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current – High			-0.4	mA
I _{OL}	Output Current – Low			8.0	mA

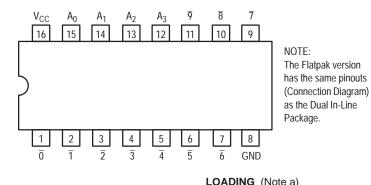




ORDERING INFORMATION

Device	Package	Shipping
SN74LS42N	16 Pin DIP	2000 Units/Box
SN74LS42D	16 Pin	2500/Tape & Reel

CONNECTION DIAGRAM DIP (TOP VIEW)

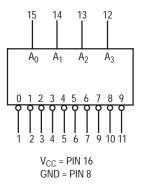


		LUADING	
PIN NAMES		HIGH	LOW
$A_0 - A_3$ $\overline{0}$ to $\overline{9}$	Address Inputs Outputs, Active LOW	0.5 U.L. 10 U.L.	0.25 U.L. 5 U.L.

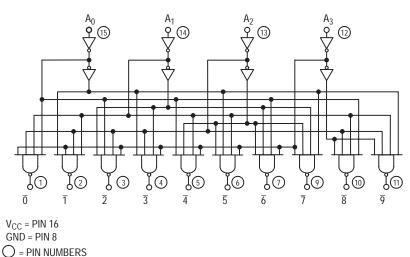
NOTES:

a) 1 TTL Unit Load (U.L.) = 40 µA HIGH/1.6 mA LOW.

LOGIC SYMBOL



LOGIC DIAGRAM



FUNCTIONAL DESCRIPTION

The LS42 decoder accepts four active HIGH BCD inputs and provides ten mutually exclusive active LOW outputs, as shown by logic symbol or diagram. The active LOW outputs facilitate addressing other MSI units with LOW input enables.

The logic design of the LS42 ensures that all outputs are HIGH when binary codes greater than nine are applied to the inputs.

The most significant input A_3 produces a useful inhibit function when the LS42 is used as a one-of-eight decoder. The A_3 input can also be used as the Data input in an 8-output demultiplexer application.

A ₀	A ₁	A ₂	A_3	Ō	1	2	3	4	5	6	7	8	9
L	L	L	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н
Н	L	L	L	н	L	Н	Н	Н	Н	Н	н	Н	н
L	Н	L	L	н	Н	L	Н	Н	Н	Н	Н	Н	н
Н	Н	L	L	Н	Н	Н	L	Н	Н	Н	Н	Н	н
L	L	Н	L	н	Н	Н	Н	L	Н	Н	Н	Н	н
н	L	Н	L	н	Н	Н	Н	Н	L	Н	Н	Н	н
L	Н	Н	L	н	Н	Н	Н	Н	Н	L	Н	н	н
н	Н	Н	L	н	Н	Н	Н	Н	Н	Н	L	н	н
L	L	L	Н	н	Н	Н	Н	Н	Н	Н	Н	L	н
н	L	L	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	L
L	Н	L	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	н
н	Н	L	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	н
L	L	Н	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	н
н	L	Н	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	н
L	Н	Н	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	н
н	Н	Н	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	н

TRUTH TABLE

H = HIGH Voltage Level

L = LOW Voltage Level

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Test C	onditions
V _{IH}	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs	
V _{IL}	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage fo All Inputs	
V _{IK}	Input Clamp Diode Voltage		-0.65	-1.5	V	$V_{CC} = MIN, I_{IN} = -18 \text{ mA}$	
V _{OH}	Output HIGH Voltage	2.7	3.5		V	$V_{CC} = MIN, I_{OH} = MAX, V_{IN} = V_{IH}$ or V_{IL} per Truth Table	
M	Output I OW/ Valtage		0.25	0.4	V	$eq:local_$	
V _{OL}	Output LOW Voltage		0.35	0.5	V		
				20	μA	$V_{CC} = MAX, V_{IN}$	= 2.7 V
ŀн	Input HIGH Current			0.1	mA	V _{CC} = MAX, V _{IN} = 7.0 V	
I _{IL}	Input LOW Current			-0.4	mA	$V_{CC} = MAX, V_{IN} = 0.4 V$	
I _{OS}	Short Circuit Current (Note 1)	-20		-100	mA	V _{CC} = MAX	
I _{CC}	Power Supply Current			13	mA	V _{CC} = MAX	

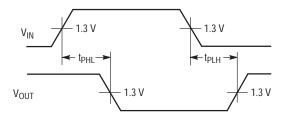
DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS (T_A = 25° C)

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Tes	at Conditions
t _{PLH} t _{PHL}	Propagation Delay (2 Levels)		15 15	25 25	ns	Figure 2	V _{CC} = 5.0 V C _L = 15 pF
t _{PLH} t _{PHL}	Propagation Delay (3 Levels)		20 20	30 30	ns	Figure 1	C _L = 15 pF

AC WAVEFORMS



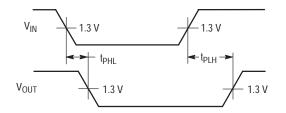
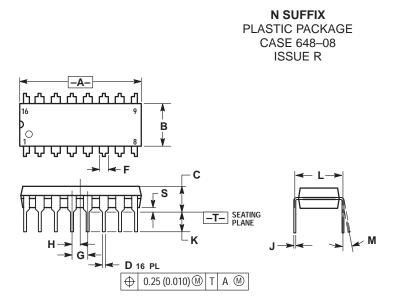


Figure 1.

Figure 2.

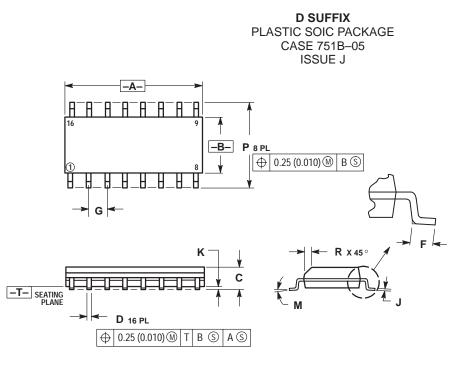
PACKAGE DIMENSIONS



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL. 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH. 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIMETERS		
DIM	MIN	MIN MAX		MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54	BSC	
Н	0.050	BSC	1.27	BSC	
J	0.008	0.015	0.21	0.38	
К	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
М	0°	10 °	0 °	10 °	
S	0.020	0.040	0.51	1.01	

PACKAGE DIMENSIONS



NOTES:

- NOTES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. ALLOWABLE DAMBAR
 PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INC	HES
DIM	MIN MAX		MIN	MAX
Α	9.80	10.00	0.386	0.393
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27	BSC	0.050) BSC
J	0.19	0.25	0.008	0.009
К	0.10	0.25	0.004	0.009
Μ	0 °	7°	0 °	7°
Р	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

Notes

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